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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/781,353	02/17/2004	Jennifer Wang	P1571	9226
7590 07/26/2005			EXAMINER	
LaRiviere, Grubman & Payne, LLP			MAI, ANH D	
P.O. Box 3140 Montorey, CA 93942			ART UNIT	PAPER NUMBER
Monterey, CA 93942			2814	

DATE MAILED: 07/26/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)			
	10/781,353	WANG ET AL.			
Office Action Summary	Examiner	Art Unit			
•	Anh D. Mai	2814			
The MAILING DATE of this communication	1	1			
Period for Reply	·				
A SHORTENED STATUTORY PERIOD FOR RE THE MAILING DATE OF THIS COMMUNICATIO - Extensions of time may be available under the provisions of 37 CFR after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a - If NO period for reply is specified above, the maximum statutory per - Failure to reply within the set or extended period for reply will, by state than three months after the material patent term adjustment. See 37 CFR 1.704(b).	N. R 1.136(a). In no event, however, may a re- reply within the statutory minimum of thirty- riod will apply and will expire SIX (6) MONT- atute, cause the application to become ABA	reply be timely filed r (30) days will be considered timely. FHS from the mailing date of this communication. ANDONED (35 U.S.C. § 133).			
Status					
1) Responsive to communication(s) filed on 0.	5 July 2005.				
,					
3) Since this application is in condition for allo	Since this application is in condition for allowance except for formal matters, prosecution as to the ments is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.				
Disposition of Claims	, ,				
· _	ion				
,	Claim(s) <u>1-22</u> is/are pending in the application. 4a) Of the above claim(s) <u>1-20</u> is/are withdrawn from consideration.				
5) Claim(s) is/are allowed.	awn nom consideration.				
6)⊠ Claim(s) <u>21 and 22</u> is/are rejected.					
7) Claim(s) is/are objected to.		•			
8) Claim(s) are subject to restriction an	d/or election requirement.				
Application Papers					
9) The specification is objected to by the Exam	niner.				
,	☑ The drawing(s) filed on 19 February 2004 is/are: a) ☑ accepted or b) ☐ objected to by the Examiner.				
Applicant may not request that any objection to	the drawing(s) be held in abeyan	ce. See 37 CFR 1.85(a).			
Replacement drawing sheet(s) including the cor	rection is required if the drawing(s) is objected to. See 37 CFR 1.121(d).			
11) The oath or declaration is objected to by the	Examiner. Note the attached	Office Action or form PTO-152.			
Priority under 35 U.S.C. § 119					
12) Acknowledgment is made of a claim for fore	eign priority under 35 U.S.C. §	119(a)-(d) or (f).			
a) ☐ All b) ☐ Some * c) ☐ None of:					
 Certified copies of the priority docum 	ents have been received.				
2. Certified copies of the priority docum					
3. Copies of the certified copies of the p	•	received in this National Stage			
application from the International Bu					
* See the attached detailed Office action for a	list of the certified copies not i	receivea.			
Address water					
Attachment(s) 1) Notice of References Cited (PTO-892)	4) Interview S	ummary (PTO-413)			
2) Notice of Draftsperson's Patent Drawing Review (PTO-948)	Paper No(s)/Mail Date			
3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB Paper No(s)/Mail Date	/08) 5) Notice of In 6) Other:	nformal Patent Application (PTO-152)			

DETAILED ACTION

Election/Restrictions

- 1. Claims 1-20 have been withdrawn from further consideration pursuant to 37 CFR 1.142(b), as being drawn to a nonelected invention, there being no allowable generic or linking claim. Applicant timely traversed the restriction (election) requirement in the reply filed on July 5, 2005.
- 2. Applicant's election of invention, Group II, claims 21-22 in the reply filed on July 5, 2005 is acknowledged. Because applicant did not distinctly and specifically point out the supposed errors in the restriction requirement, the election has been treated as an election without traverse (MPEP § 818.03(a)).

The requirement is still deemed proper and is therefore made FINAL.

Specification

3. The title of the invention is not descriptive. A new title is required that is clearly indicative of the invention to which the claims are directed.

The following title is suggested: VIA FORMED IN A POLYMER LAYER

Claim Objections

- 4. Claims 21 and 22 are objected to because of the following informalities:
- Claim 21, line 2 recites: <u>said</u> polymer layer. The correct term should be -- <u>a</u> polymer layer --.
- Claim 22, line 2 recites: said semiconductor substrate. The correct term should be -- a semiconductor substrate --.

Appropriate correction is required.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 5. Claim 21 is rejected under 35 U.S.C. 102(b) as being anticipated by Yu et al. (U.S. Patent No. 6,004,883).

With respect to claim 21, insofar as the device is concerned, Yu teaches a device including a via as claimed including:

- a hard-mask (18) on a polymer layer (16);
- a photoresist mask (20) on the hard-mask (18);
- a via hole (25) with vertical sidewalls formed in the polymer layer. (See Fig. 3).

Product by process limitation:

The expression "placing" and "releasing a first fluoride gas into a chamber to etch a hard-mask opening for defining said via hole; and releasing a second fluoride gas into said chamber to etch an exposed portion of said polymer layer defining said via hole with vertical sidewalls" is/are taken to be a product by process limitation and is given no patentable weight. A product by process claim directed to the product per se, no matter how actually made, In re Hirao, 190 USPQ 15 at 17 (footnote 3). See In re Fessman, 180 USPQ 324, 326 (CCPA 1974); In re Marosi et al., 218 USPQ 289, 292 (Fed. Cir. 1983); In re Brown, 459 F.2d 531, 535, 173 USPQ 685, 688 (CCPA 1972); In re Pilkington, 411

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F.2d 1345, 1348, 162 USPQ 145, 147 (CCPA 1969); Buono v. Yankee Maid Dress Corp., 77 F.2d 274, 279, 26 USPQ 57, 61 (2d. Cir. 1935); and particularly In re Thorpe, 227 USPQ 964, 966 (Fed. Cir. 1985), all of which make it clear that it is the patentability of the final structure of the product "gleaned" from the process steps, which must be determined in a "product by process" claim, and not the patentability of the process. See also MPEP 2113. Moreover, an old and obvious product produced by a new method is not a patentable product, whether claimed in "product by process" claims or not.

Note that Applicant has burden of proof in such cases as the above case law makes clear.

6. Claim 22 is rejected under 35 U.S.C. 102(b) as being anticipated by Schuck, III et al. (U.S. Patent No. 5,868,951).

With respect to claim 22, insofar as the device as concerned, Schuck teaches a device having a via as claimed including:

a polymer layer having sub-micron wide tapered sidewalls via-opening on a semiconductor substrate; and

a hard-mask having sub-micron wide via-opening on the polymer layer. (See Fig. 4A).

Product by process limitation:

The expression "placing in a chamber"; "defining"; "deposited" "releasing a third fluoride gas into said chamber; applying bias power within the range of approximately 105 Watts to approximately 120 Watts; applying pulse-modulated power

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within the range of approximately 725 Watts to approximately 755 Watts; pressurizing said third fluoride gas within a range of approximately 5 milli-Torr to approximately 20 milli-Torr; and continuing the above steps until etching said hard-mark and an exposed portion of said polymer layer proximal to said sub-micron wide via-opening creating tapered sidewalls" is/are taken to be a product by process limitation and is given no patentable weight. A product by process claim directed to the product per se, no matter how actually made, In re Hirao, 190 USPQ 15 at 17 (footnote 3). See In re Fessman, 180 USPO 324, 326 (CCPA 1974); In re Marosi et al., 218 USPO 289, 292 (Fed. Cir. 1983); In re Brown, 459 F.2d 531, 535, 173 USPO 685, 688 (CCPA 1972); In re Pilkington, 411 F.2d 1345, 1348, 162 USPO 145, 147 (CCPA 1969); Buono v. Yankee Maid Dress Corp., 77 F.2d 274, 279, 26 USPQ 57, 61 (2d. Cir. 1935); and particularly In re Thorpe, 227 USPO 964, 966 (Fed. Cir. 1985), all of which make it clear that it is the patentability of the final structure of the product "gleaned" from the process steps, which must be determined in a "product by process" claim, and not the patentability of the process. See also MPEP 2113. Moreover, an old and obvious product produced by a new method is not a patentable product, whether claimed in "product by process" claims or not.

Note that Applicant has burden of proof in such cases as the above case law makes clear.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Anh D. Mai whose telephone number is (571) 272-1710. The examiner can normally be reached on 8:00AM-5:00PM.

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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on (571) 272-1705. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

PRIMARY EXAMINER